

CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8)Applicant(s): **Jonathan A. Noquil, et al.**

Docket No.

90065.001400/17732.67130.00

Application No.

10/803,464

Filing Date

March 18, 2004

Examiner

Tuan Quach

Customer No.

34799

Group Art Unit

2826

Invention: **MULTI-FLIP CHIP ON LEAD FRAME ON OVER MOLDED IC PACKAGE AND METHOD
OF ASSEMBLY**

I hereby certify that this **Amendment (7 pages)***(Identify type of correspondence)*

is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on **July 22, 2005**

*(Date)***Kathleen A. Manczuk***(Typed or Printed Name of Person Mailing Correspondence)**Kathleen A. Manczuk**(Signature of Person Mailing Correspondence)***Note: Each paper must have its own certificate of mailing.**



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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Applicant:	Noquil, et al.)	Examiner:
)	Tuan Quach
Serial No.:	10/803,464)	
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Filed:	March 18, 2004)	Art Unit:
)	2826
For:	MULTI-FLIP CHIP ON LEAD FRAME ON OVER)		
	MOLDED IC PACKAGE AND METHOD OF)	
	ASSEMBLY)	

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed February 25, 2005, please amend this application in the Claims as follows.

07/27/2005 BABRAHA1 00000027 10803464

02 FC:1201 400.00 OP